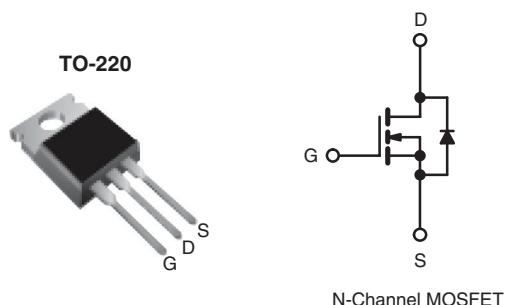


## Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	50	
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = 10$ V	0.024
$Q_g$ (Max.) (nC)	66	
$Q_{gs}$ (nC)	21	
$Q_{gd}$ (nC)	25	
Configuration	Single	



### FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Parallelizing
- Simple Drive Requirements
- Lead (Pb)-free Available



**RoHS\***  
COMPLIANT

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRFZ46PbF SiHFZ46-E3
SnPb	IRFZ46 SiHFZ46

### ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	50	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current <sup>e</sup>	$I_D$	50	A
Continuous Drain Current		38	
Pulsed Drain Current <sup>a</sup>	$I_{DM}$	220	
Linear Derating Factor		1.0	W/C
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	100	mJ
Maximum Power Dissipation	$P_D$	150	W
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for 10 s	300	
Mounting Torque		10	lbf · in
		1.1	N · m

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 25$  V, starting  $T_J = 25$  °C,  $L = 34 \mu\text{H}$ ,  $R_G = 25 \Omega$ ,  $I_{AS} = 54$  A (see fig. 12).
- $I_{SD} \leq 54$  A,  $dI/dt \leq 250$  A/μs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.
- 1.6 mm from case
- Current limited by the package, (die current = 54 A).

\* Pb containing terminations are not RoHS compliant, exemptions may apply

**THERMAL RESISTANCE RATINGS**

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	$^{\circ}\text{C}/\text{W}$
Case-to-Sink, Flat, Greased Surface	$R_{thCS}$	0.50	-	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.0	

**SPECIFICATIONS**  $T_J = 25 \text{ }^{\circ}\text{C}$ , unless otherwise noted

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}$	$I_D = 250 \mu\text{A}$	50	-	-	V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25 \text{ }^{\circ}\text{C}$ , $I_D = 1 \text{ mA}$		-	0.057	-	$\text{V}/\text{C}$	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$		2.0	-	4.0	V	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20$		-	-	$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 50 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	-	25	$\mu\text{A}$	
		$V_{DS} = 48 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 150 \text{ }^{\circ}\text{C}$		-	-	250		
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$	$I_D = 32 \text{ A}^b$	-	-	0.024	$\Omega$	
Forward Transconductance	$g_{fs}$	$V_{DS} = 25 \text{ V}$ , $I_D = 32 \text{ A}^b$		27	-	-	S	
<b>Dynamic</b>								
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1.0 \text{ MHz}$ , see fig. 5		-	1800	-	pF	
Output Capacitance	$C_{oss}$			-	960	-		
Reverse Transfer Capacitance	$C_{rss}$			-	160	-		
Total Gate Charge	$Q_g$	$V_{GS} = 10 \text{ V}$	$I_D = 54 \text{ A}$ , $V_{DS} = 48 \text{ V}$ , see fig. 6 and 13 <sup>b</sup>	-	-	66	nC	
Gate-Source Charge	$Q_{gs}$			-	-	21		
Gate-Drain Charge	$Q_{gd}$			-	-	25		
Turn-On Delay Time	$t_{d(on)}$			-	12	-		
Rise Time	$t_r$	$V_{DD} = 28 \text{ V}$ , $I_D = 54 \text{ A}$ , $R_G = 9.1 \Omega$ , $R_D = 0.49 \Omega$ , see fig. 10 <sup>b</sup>		-	120	-	ns	
Turn-Off Delay Time	$t_{d(off)}$			-	42	-		
Fall Time	$t_f$			-	95	-		
Internal Drain Inductance	$L_D$			-	4.5	-	nH	
Internal Source Inductance	$L_S$	Between lead, 6 mm (0.25") from package and center of die contact		-	7.5	-		
<b>Drain-Source Body Diode Characteristics</b>								
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50 <sup>c</sup>	A	
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$			-	-	220		
Body Diode Voltage	$V_{SD}$	$T_J = 25 \text{ }^{\circ}\text{C}$ , $I_S = 54 \text{ A}$ , $V_{GS} = 0 \text{ V}^b$		-	-	2.5	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25 \text{ }^{\circ}\text{C}$ , $I_F = 54 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	66	99	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	0.17	0.31	$\mu\text{C}$	
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						

**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).  
b. Pulse width  $\leq 300 \mu\text{s}$ ; duty cycle  $\leq 2 \%$ .  
c. Current limited by the package, (die current = 54 A).

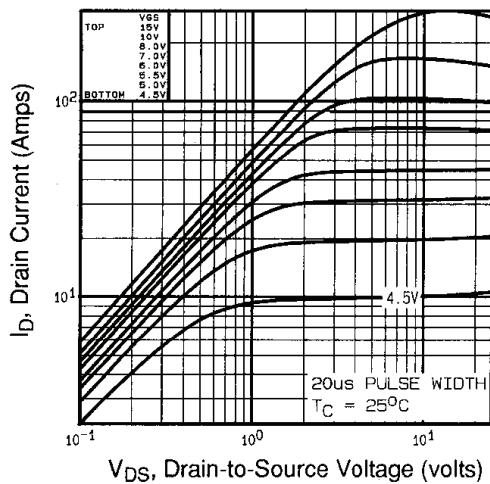
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


Fig. 1 - Typical Output Characteristics,  $T_C = 25\text{ }^{\circ}\text{C}$

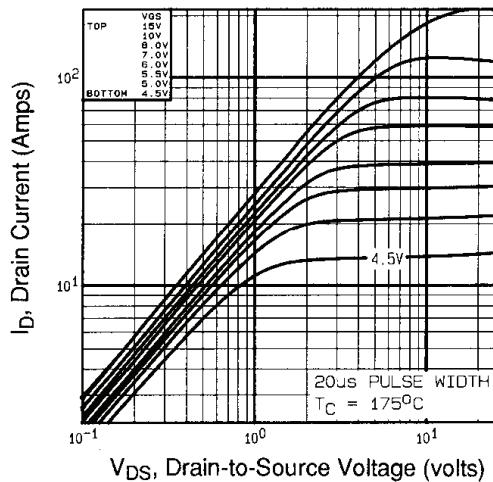
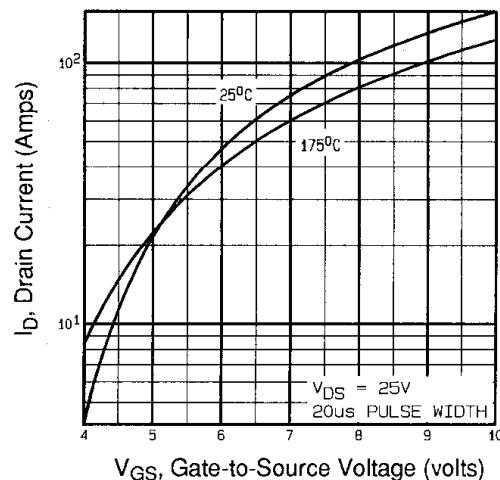
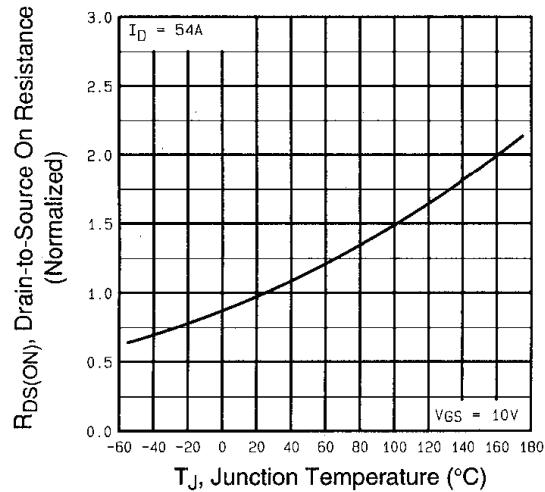


Fig. 2 - Typical Output Characteristics,  $T_C = 175\text{ }^{\circ}\text{C}$



# IRFZ46, SiHFZ46

Vishay Siliconix

Power MOSFET

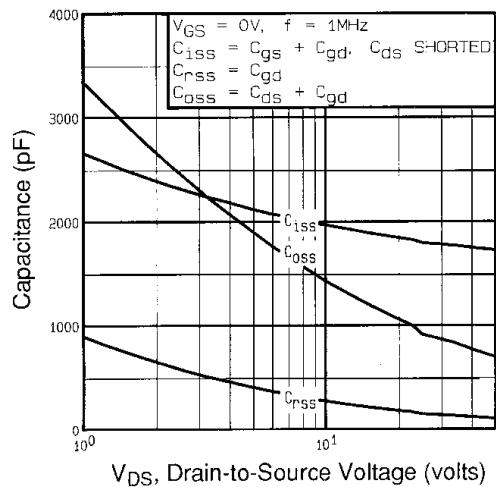


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

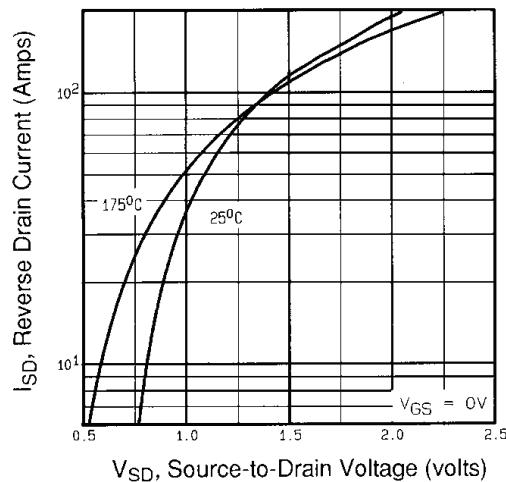


Fig. 7 - Typical Source-Drain Diode Forward Voltage

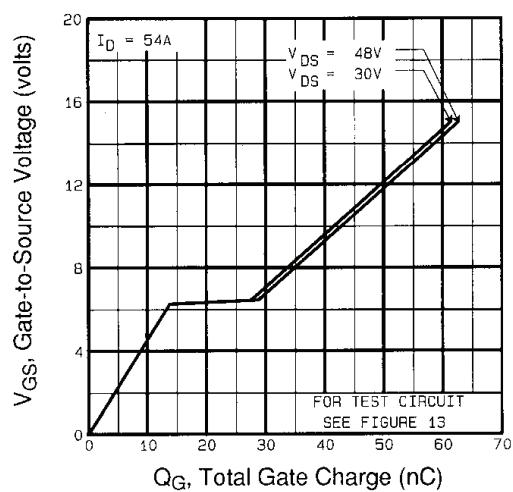


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

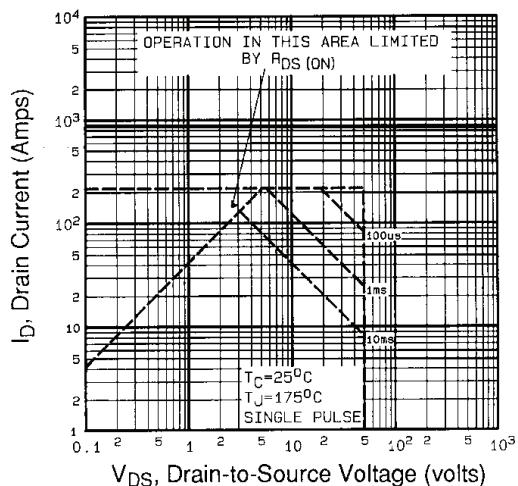
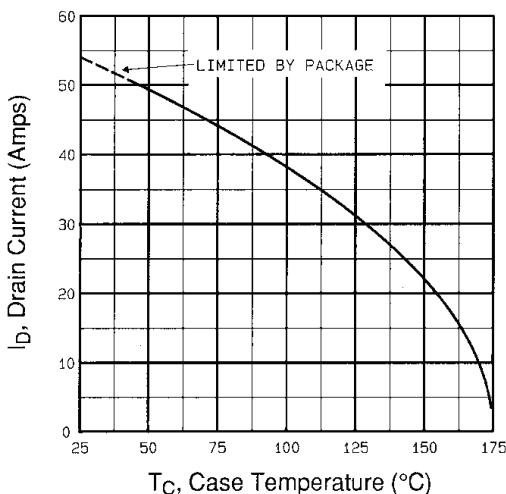
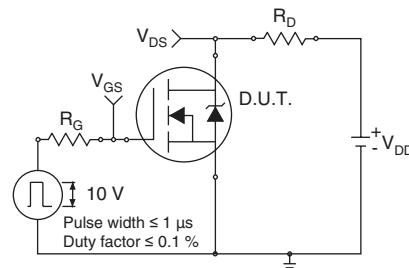
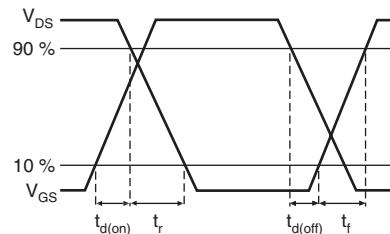
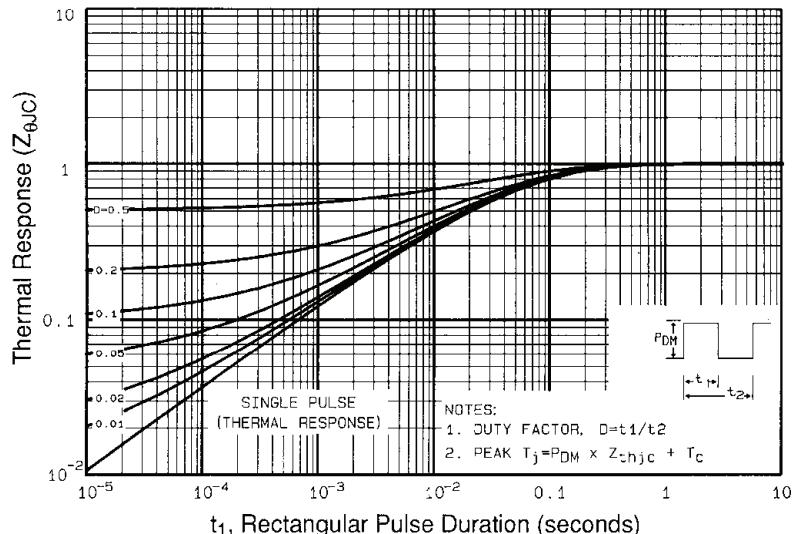
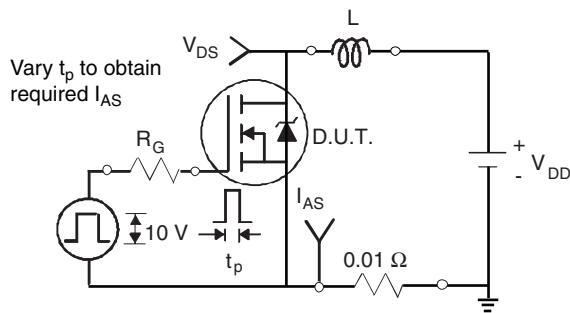
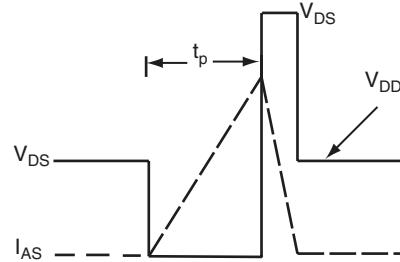


Fig. 8 - Maximum Safe Operating Area


**Fig. 9 - Maximum Drain Current vs. Case Temperature**

**Fig. 10a - Switching Time Test Circuit**

**Fig. 10b - Switching Time Waveforms**

**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

**Fig. 12a - Unclamped Inductive Test Circuit**

**Fig. 12b - Unclamped Inductive Waveforms**

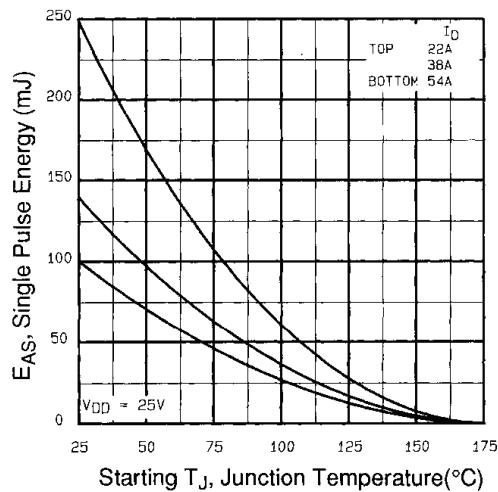


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

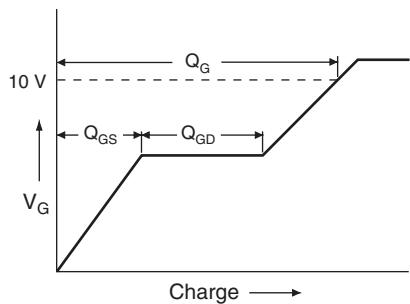


Fig. 13a - Basic Gate Charge Waveform

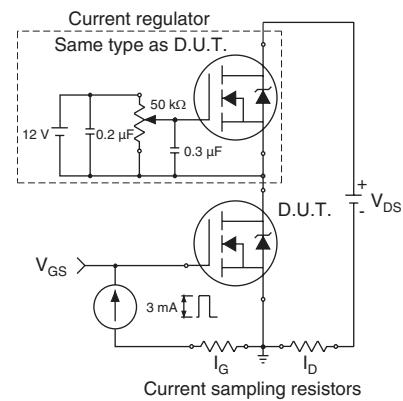
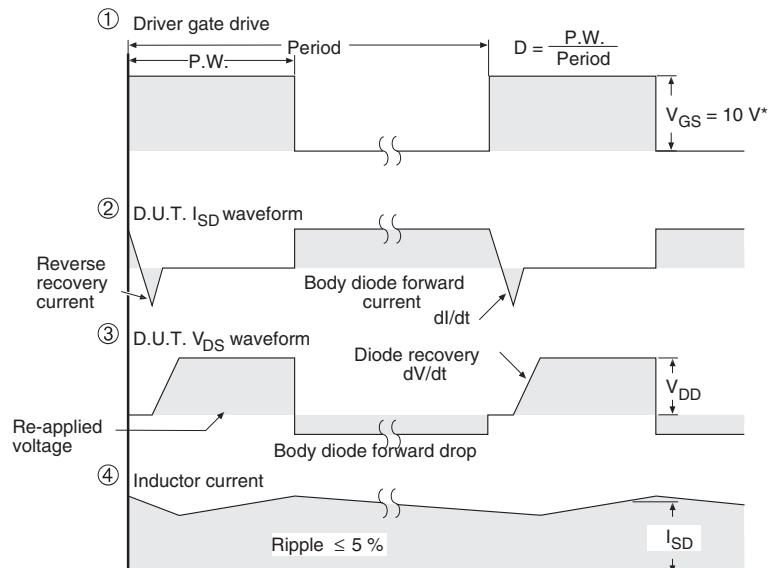
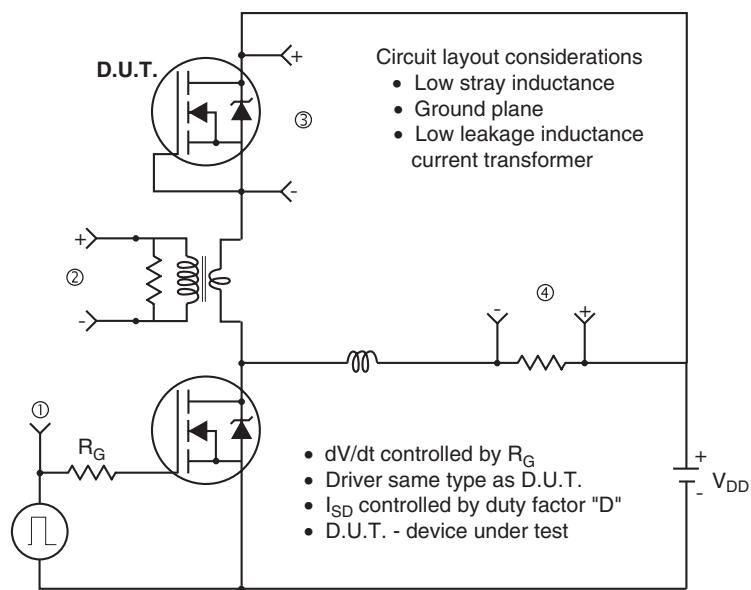


Fig. 13b - Gate Charge Test Circuit

### Peak Diode Recovery dV/dt Test Circuit



\*  $V_{GS} = 5 \text{ V}$  for logic level devices

**Fig. 14 - For N-Channel**

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